Lighting Color

• Amber

# LN417YPH

## Square Type

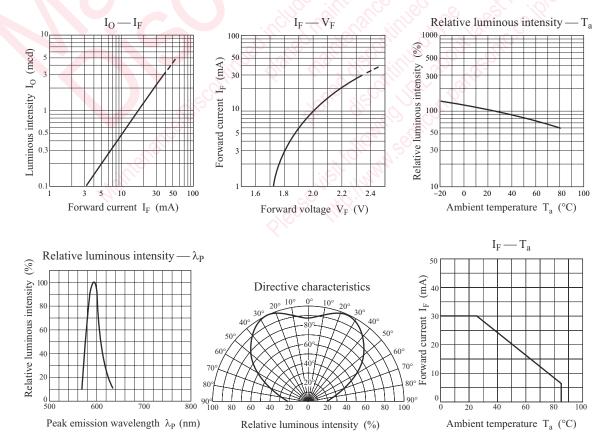
 $\Box$  5.3 mm  $\times$  1.8 mm

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Power dissipation	P <sub>D</sub>	90	mW	
Forward current	I <sub>F</sub>	30	mA	
Pulse forward current *	I <sub>FP</sub>	150	mA	
Reverse voltage	V <sub>R</sub>	4	v	
Operating ambient temperature	T <sub>opr</sub>	-25 to +85	°C	
Storage temperature	T <sub>stg</sub>	-30 to +100	°C	

#### Electro-Optical Characteristics $T_a = 25^{\circ}C$

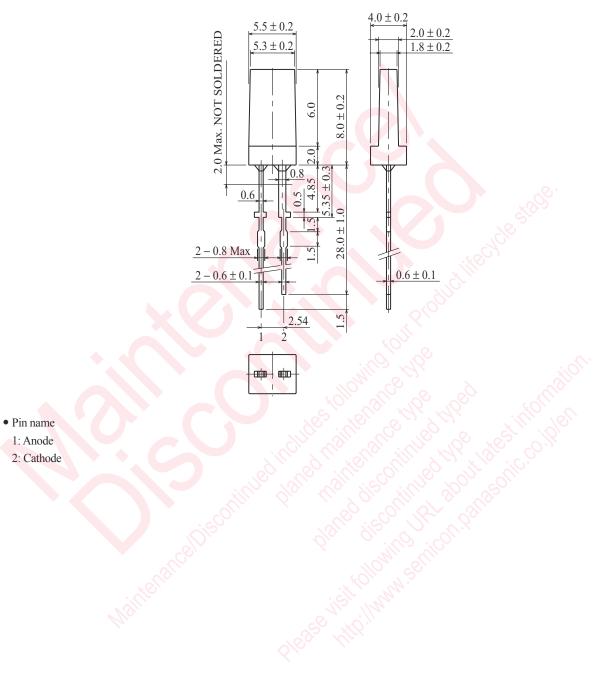
	11						
Reverse voltage	V <sub>R</sub>	4	V				
Operating ambient temperature	T <sub>opr</sub>	-25 to +85	°C				
Storage temperature	T <sub>stg</sub>	-30 to +100	°C				
Note) *: The condition of I <sub>FP</sub> is duty 10%, Pulse with	dth 1 msec.						
Electro-Optical Characteristics $T_a =$	= 25°C			t inco			
Parameter	Symbol		Conditions	Min	Тур	Max	Unit
Luminous intensity	Io			0.6	1.5		mcd
Reverse current	I <sub>R</sub>	$V_R = 4 V$	400			10	μΑ
Forward voltage	V <sub>F</sub>	$I_F = 20 \text{ mA}$	He Chi		2.2	2.8	V
Peak emission wavelength	$\lambda_{\rm P}$	$I_F = 20 \text{ mA}$	Mon Ros S	60	590	CO.	nm
Spectral half band width	Δλ	$I_F = 20 \text{ mA}$	and the share	R	. 30	201	nm



### LN417YPH

Package (Unit: mm)





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